





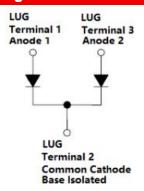
### 306CMQ200 SCHOTTKY RECTIFIER



#### **Features**

- 175°C T<sub>J</sub> operation
- · Center tap module
- High purity, high temperature epoxy encapsulation for
- · enhanced mechanical strength and moisture resistance
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Baseplate: Nickel plated; Terminals: Nickel plated
- This is a Pb Free Device
- . All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

### **Circuit Diagram**



### **Applications**

- · High current switching power supply
- Plating power supply
- Free-Wheeling diodes
- Reverse battery protection
- Converters
- UPS System
- Welding

### **Maximum Ratings:**

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	-	200	V
Average Rectified Forward Current	I <sub>F(AV)</sub>	50% duty cycle @Tc=121°C, rectangular wave form	150(Per Leg) 300(Per Device)	А
Peak One Cycle Non-Repetitive Surge Current (Per Leg)	Ігѕм	8.3 ms, half Sine pulse	3840	Α

- China Germany Korea Singapore United States
  - http://www.smc-diodes.com sales@ smc-diodes.com •







## **Electrical Characteristics:**

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop(Per Leg)*	V <sub>F1</sub>	@ 150A, Pulse, T <sub>J</sub> = 25 °C @ 300A, Pulse, T <sub>J</sub> = 25 °C	0.84 -	0.86 1.03	V
	V <sub>F2</sub>	@ 150A, Pulse, T <sub>J</sub> = 125 °C @ 300A, Pulse, T <sub>J</sub> = 125 °C	0.71 -	0.76 0.86	V
Reverse Current(Per Leg)*	I <sub>R1</sub>	$@V_R = \text{rated } V_{R,} T_J = 25  ^{\circ}\text{C}$	0.0001	10	mA
	I <sub>R2</sub>	$@V_R = \text{rated } V_{R,} T_J = 125  ^{\circ}\text{C}$	0.8	90	mA
Junction Capacitance(Per leg)	Ст	$@V_R = 5V, T_C = 25 °C$ $f_{SIG} = 1MHz$	2300	3500	pF
Voltage Rate of Change	dv/dt	-	-	10,000	V/μs

<sup>\*</sup> Pulse width < 300 µs, duty cycle < 2%

# **Thermal-Mechanical Specifications:**

Characteristics	Symbol	Condition	Specification		Units
Junction Temperature	ΤJ	-	-55 to +175		°C
Storage Temperature	T <sub>stg</sub>	-	-55 to +175		°C
Typical Thermal Resistance Junction to Case(Per leg)	$R_{ heta JC}$	DC operation	0.50		°C/W
Typical Thermal Resistance Junction to Case(Per package)	R <sub>0</sub> JC	DC operation	0.25		°C/W
Typical Thermal Resistance, case to Heat Sink	$R_{ heta cs}$	Mounting surface, smooth and greased	0.10		°C/W
Mounting Torque	T <sub>M</sub>	-	Mounting Torque Terminal	24(min) 35(max) 35(min)	Kg-cm
			Torque	46(max)	
Approximate Weight	wt	-	79		g
Case Style	PRM4 Isolated				

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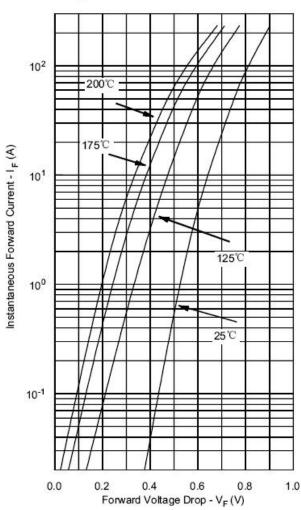




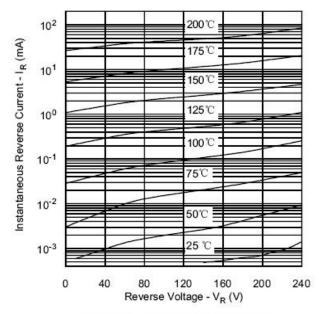


## **Ratings and Characteristics Curves**

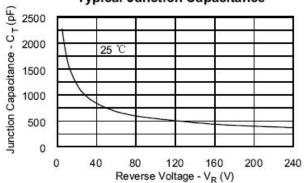
### **Typical Forward Characteristics**



#### Typical Reverse Characteristics



#### **Typical Junction Capacitance**



<sup>•</sup> China - Germany - Korea - Singapore - United States •

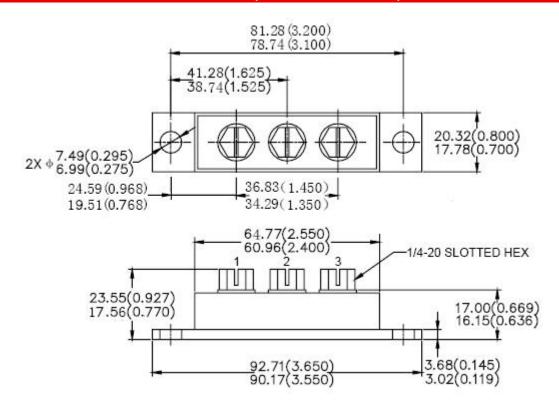
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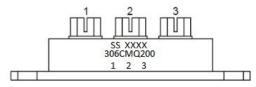




### **Mechanical Dimensions PRM4 Isolated(Millimeters/Inches)**



### **Marking Diagram**



Where XXXX is YYWW

306CMQ200 = Part name SS = SS YY = Year WW = Week

**Cautions:** Molding resin Epoxy resin UL:94V-0

### **Ordering Information**

Device	Package	Shipping	
306CMQ200	PRM4 Isolated (Pb-Free)	9 pcs/box	

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.









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